

GP1S296HCPSF

Gap : 1.0mm, Slit : 0.2mm
Phototransistor Output,
Compact Transmissive
Photointerrupter



■Description

GP1S296HCPSF is a compact and low-profile, transmissive photointerrupter with photo-transistor output and detects an object between the emitter and the detector.

The compact package has been molded by a unique technology that is a combination of transfer and injection molding.

This product is a surface-mount type.

■Agency approvals/Compliance

1. Compliant with RoHS directive (2002/95/EC)

■Applications

1. General purpose detection of object presence or motion.
Example : printer, lens control for camera,
various mechanical position detection

■Features

1. Transmissive with phototransistor output
2. Gap Width : 1.0mm
3. Slit Width (detector side): 0.2mm
4. Package : 2.5×1.8×1.9mm
5. RoHS directive compliant

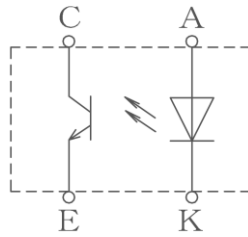
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Sheet No.: OP13015EN

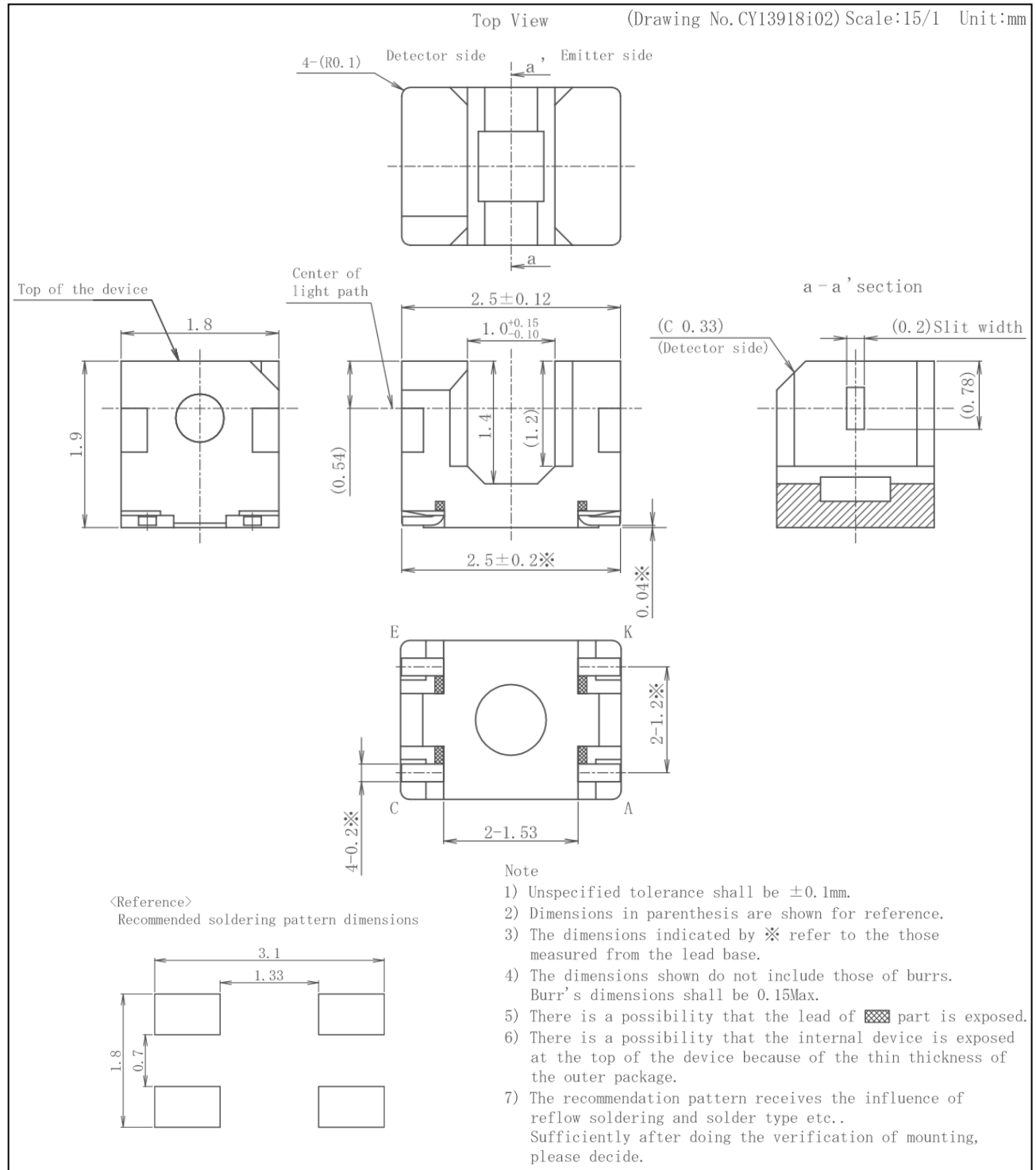
Internal Connection Diagram

Top View



A : Anode
K : Cathode
C : Collector
E : Emitter

Outline Dimensions



■Absolute Maximum Ratings

Ta=25°C

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	30	mA
	Reverse voltage	V_R	6	V
	Power dissipation	P	60	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_c	20	mA
	Collector power dissipation	P_c	60	mW
Total power dissipation		P_{tot}	80	mW
Operating temperature		T_{opr}	-25 to +85	°C
Storage temperature		T_{stg}	-40 to +100	°C
* Soldering temperature		T_{sol}	260	°C

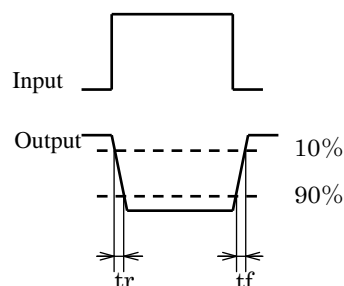
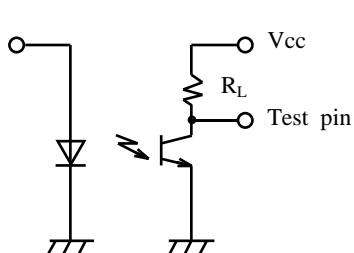
* Soldering time : 3 s or less

■Electro-optical characteristics

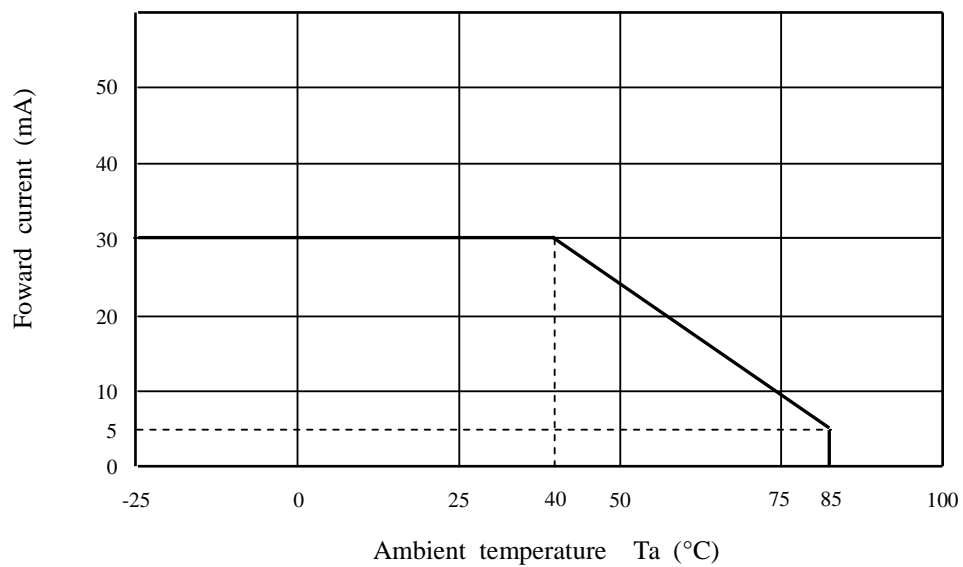
Ta=25°C

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	$I_F=20\text{mA}$	-	1.2	1.4	V
	Reverse current	I_R	$V_R=3\text{V}$	-	-	10	μA
Output	Collector dark current	I_{CEO}	$V_{CE}=20\text{V}$	-	-	100	nA
Transfer characteristics	Collector current	I_c	$V_{CE}=5\text{V}, I_F=5\text{mA}$	150	-	600	μA
	Response time	(Rise)	$V_{CE}=5\text{V}, I_c=100\mu\text{A}$ $R_L=1\text{k}\Omega$	-	50	150	μs
		(Fall)		-	50	150	μs
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F=10\text{mA}, I_c=40\mu\text{A}$	-	-	0.4	V

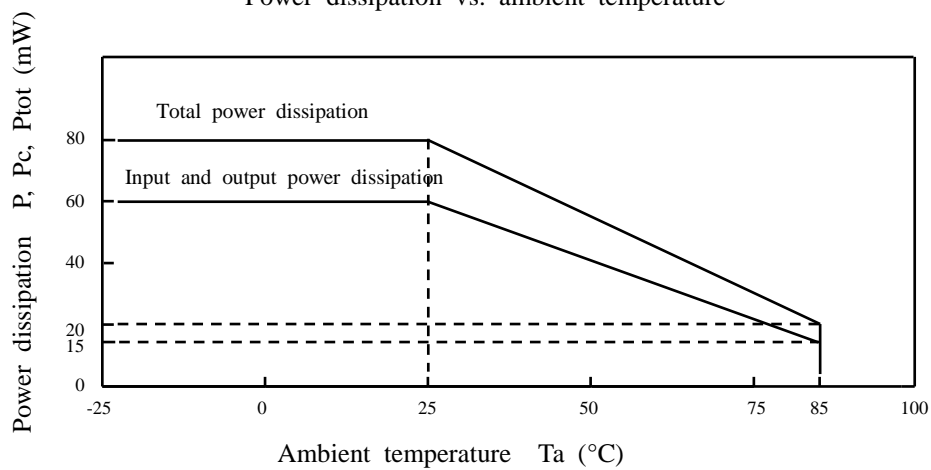
(Test circuit for response time)



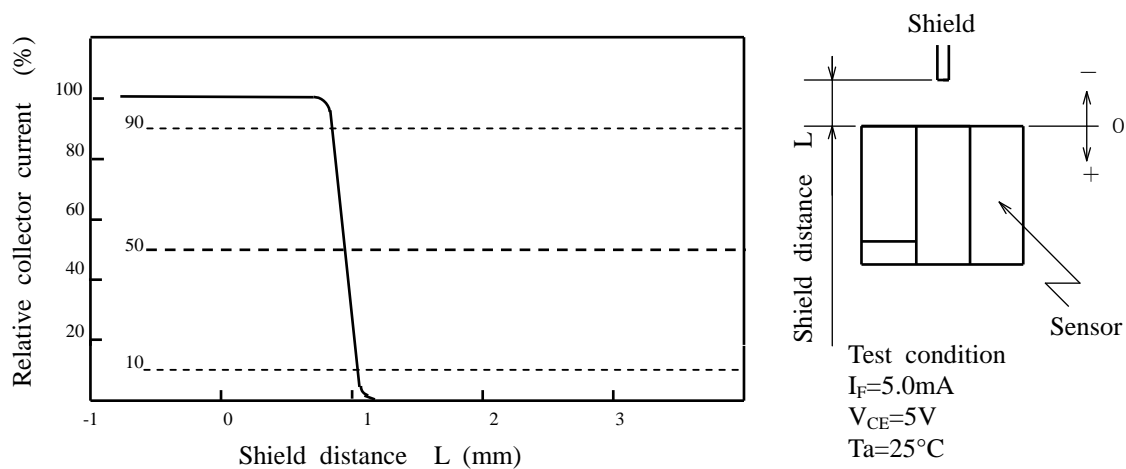
Foward current vs. ambient temperature



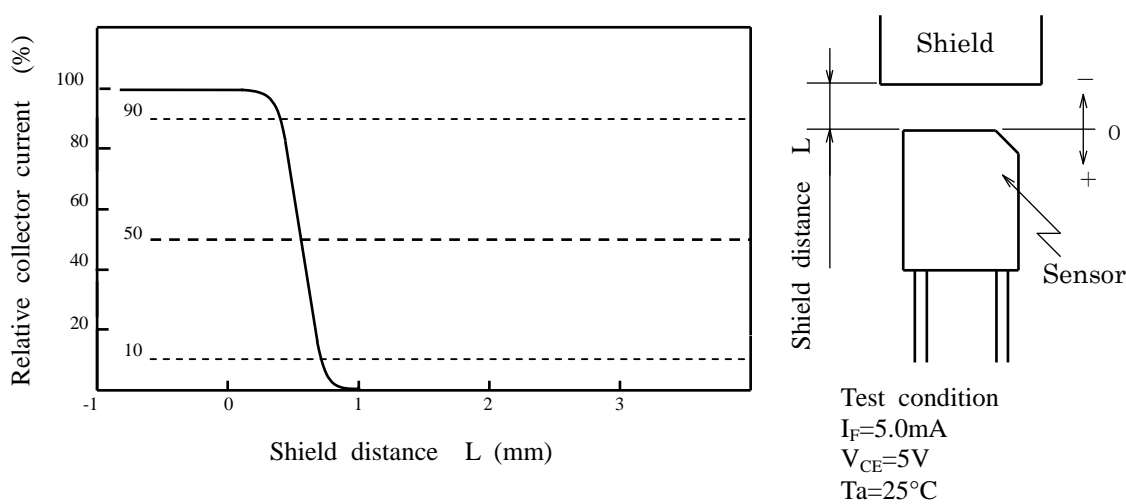
Power dissipation vs. ambient temperature



Relative collector current vs. shield distance 1 (Reference value)



Relative collector current vs. shield distance 2 (Reference value)



■Supplements

- Parts

Refer to the attached sheet, Page 8.

- Packing

Refer to the attached drawing No. CY13919i09

- ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

- Specified brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.

- Compliance with each regulation

- 1) The RoHS directive(2002/95/EC)

This product complies with the RoHS directive(2002/95/EC) .

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

- 2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information

Products Regulation (Chinese : 电子信息产品污染控制管理办法).

Category	Toxic and hazardous substances					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Photointerrupter	✓	✓	✓	✓	✓	✓

✓ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard.

- Product mass : Approx. 10mg

- Country of origin : China

- Taping specification : Refer to the attachment-2.

- Moisture-proof package specification : Refer to the attachment-3.

■Notes

●Circuit design

In circuit designing, make allowance for the degradation of the light emitting diode output that results from long continuous operation. (50% degradation/5 years)

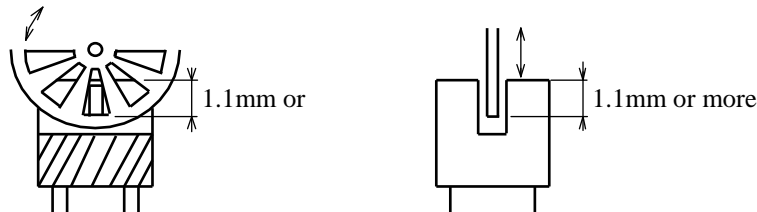
●Prevention of detection error

To prevent photointerrupter from faulty operation caused by external light, do not set the detecting face to the external light.

●Position of opaque board

Opaque board shall be installed at place 1.1mm or more from the top of elements.

(Example)



●Print circuit board design

Because a portion of the internal lead may be exposed at the back of the product, please consider it in the pattern design for a print circuit board design.

●Soldering

(1) Reflow soldering

Please do only one soldering at the temperature and the time within the temperature profile in attachment-1.

(2) Hand soldering

To solder onto lead pins, please solder at 260°C for 3 seconds or less.

Please also take care not to let mechanical stress exert on package and lead pins when soldering.

Please have soldering adjustment, etc. after GP1S296HCPSF is cooled down, and also note that the outer mold resin may be meltdown by heating for a long time.

Since the tip of the lead has exposed lead frame base material, there is a case not to be soldered, so please consider the soldering pattern on a print circuit board to solder well with the bottom and side surface of the lead.

●Cleaning

Cleaning shall be carried out under the below conditions to avoid keeping solvent, solder and flux on the device.

(1) Solvent cleaning : Solvent temperature 45°C or less, Immersion for 3 min. or less

(2) Ultrasonic cleaning : Since the influence to the product may changes by the conditions of the ultrasonic power, time, the tank size, PCB size, the product installation condition, etc., please evaluate with actual conditions and confirm before usage.

(3) The cleaning shall be carried out with solvent below.

Solvent : Ethyl alcohol, Methyl alcohol

●Lead pin

Lead terminals of this product have Copper, Nickel, Palladium and Gold plating.

Before usage, please evaluate solder ability with actual conditions and confirm.

The uniformity in color for the lead terminals are not specified.

●Storage and management after open

1) Storage condition : Storage shall be in accordance with the below conditions.

Storage temp. : 5 to 30°C

Storage humidity : 70%RH or less

2) Treatment after open

(1) After open, please mount at the conditions of humidity 60%RH or less and temperature 5 to 25°C within 2 days.

(2) In case of long time storage after open, please storage at the conditions of humidity 70%RH or less and temperature 5 to 30°C by using dry box or resealing with desiccant in moisture-proof bag by sealer and mount within 2 weeks.

●Baking before mounting

In case that it could not carry out the above treatment, it is able to mount with baking treatment.

However baking treatment shall be limited only 1 time. Although it is possible to have baking treatment with taping package, please bake it by putting a reel with standing situation. Please do not lay it down since it may change the reel shape and occur a mounting problem. Since a label and a fixing tape for the carrier tape does not have enough heat resistance, there may be a case to leave some paste.

Recommended baking conditions : 100°C, 16 to 24 hours

■Parts

This product uses the below parts.

1) Light detector (Quantity : 1)

Type	Material	Maximum sensitivity (nm)	Sensitivity (nm)	Response time (μs)
Phototransistor	Silicon (Si)	930	700 to 1200	20

2)Light emitter (Quantity : 1)

Type	Material	Maximum light emitting wavelength (nm)	I/O Frequency (MHz)
Infrared light emitting diode (non-coherent)	GaAs	940	0.3

3) Material

Case	Lead frame	Lead frame plating
Black PPS resin (UL 94V-0)	42 Alloy	Au-Pd-Ni-Cu

4) Others

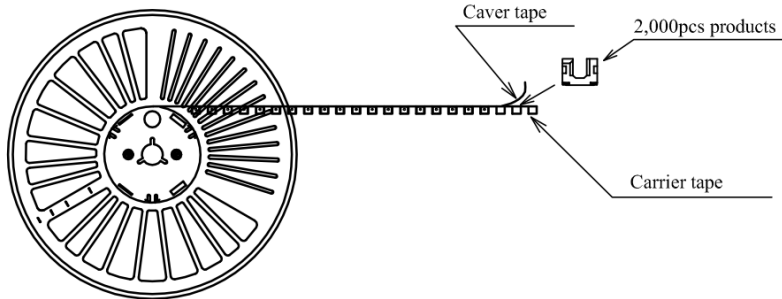
This product shall not be proof against radiation flux.

■Packing

6.5 Packing (Drawing No.CY13919i09)

6.5.1 Inner Packing

① Inner Packaging drawing

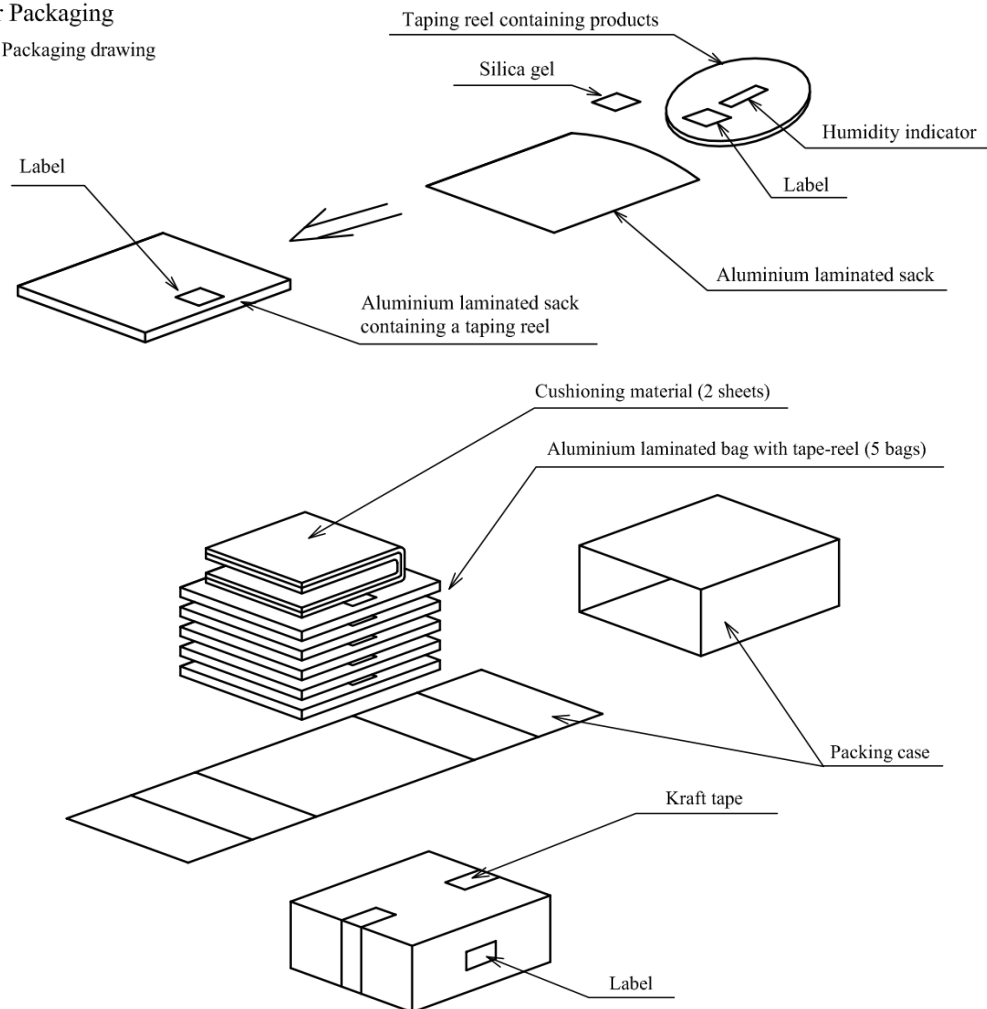


② Inner packing material : • Reel(PPE) • Carrier tape (PC) • Caver tape(PET)

③ Quantity : 2,000pcs./Reel

6.5.2 Outer Packaging

① Outer Packaging drawing



② Outer packing material: Packing case(Corrugated cardboard), Cushioning material (Urethane)
Aluminium laminated bag (Alumi-Polyethylene)

Humidity indicator card (paper), Label(paper), silica gel, craft tape

③ Quantity: 10,000pcs./box

④ The contents of the carton indication conforms to EIAJ C-3 and the following items are indicated.

Model No., Internal production control name, Quantity, Packing date, Corporate name, Country of origin

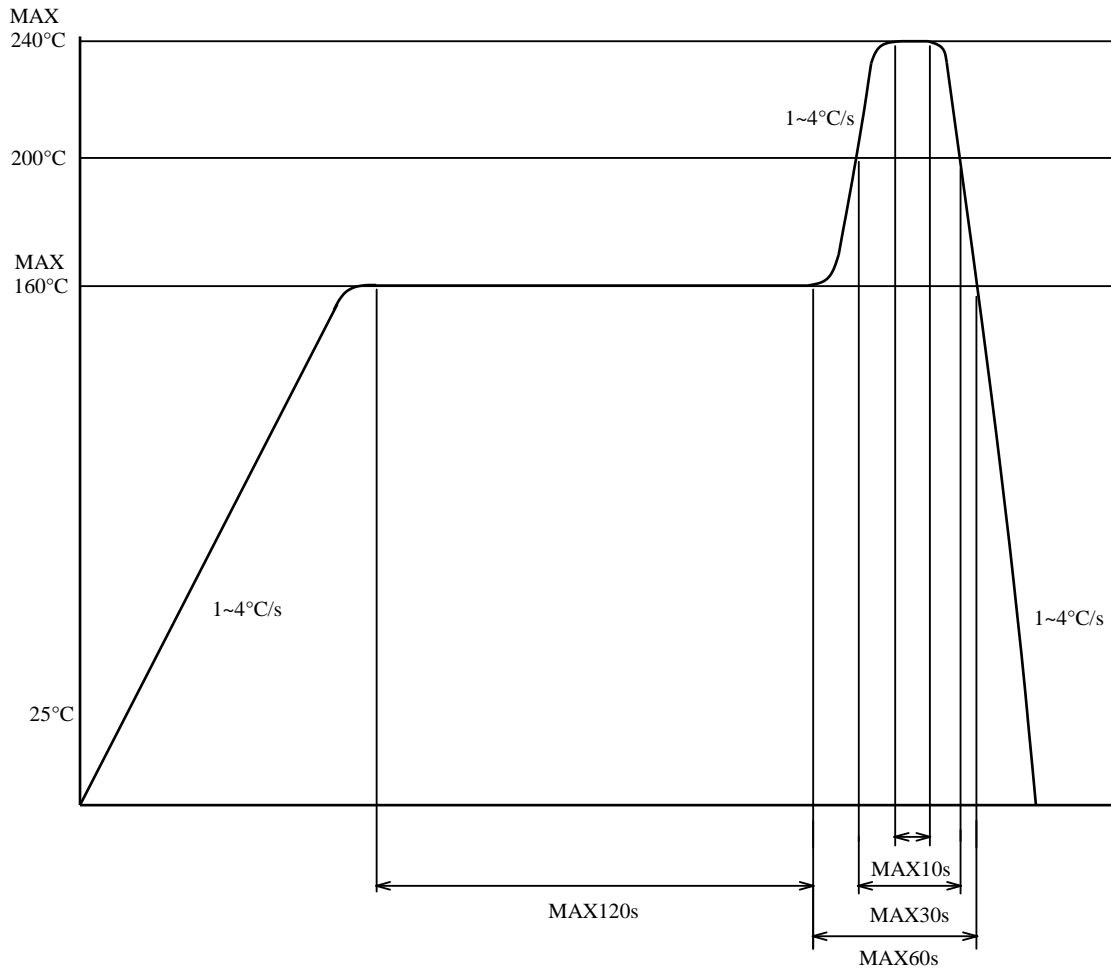
⑤ Regular packaged mass: Approximately 700g

(Attachment-1)

Precautions for Soldering photointerrupter

1) In case of reflow soldering,

Please do only one soldering at the temperature and the time within the temperature profile as shown in the figure below.



2) Other precautions

An infrared lamp used to heat up for soldering may cause a localized temperature rise in the resin. So keep the package temperature within that specified in Item 1.

Also avoid immersing the resin part in the solder.

Even if within the temperature profile above, there is the possibility that the gold wire in package is broken in case that the deformation of PCB gives the affection to lead pins. Please use after confirmation the conditions fully by actual solder reflow machine.

(Attachment-2-1)

Package specifications (ϕ 180mm reel)

1) Application

This specification applies to the taping specifications and the relation items for the GP1S296HCPSF.

2) Taping method

(1) Tape structure and Dimensions (Refer to the attached sheets-2-2)

① The tape shall have a structure in which a cover tape is sealed pressed on the carrier tape made by polystyrene to protect against static electricity.

(2) Reel structure and Dimensions (Refer to the attached sheets-2-3)

(3) Direction of product insertion (Refer to the attached sheets-2-3)

① Product direction in carrier tape shall direct to the detector at the hole side on the tape.

3) Repair method of sealing error

(1) In case of repairing a sealing error, three sides of a cover tape matching to the product insertion portion are opened by a cutter and it will be closed by adhesiveness tape after repairing.

4) Adhesiveness of cover tape

(1) The exhalation force between carrier tape and cover tape shall be 0.2N to 1.0N for the angle from 160° to 180°.

5) Rolling method and quantity

(1) Wind the tape back on the reel so that the cover tape will be outside the tape.

(2) Attach more than 20cm of blank tape to the trailer and attach more than 28cm of the leader to the tape and fix the both ends with adhesive tape.

(3) One reel shall contain 2,000 pcs.

6) Indication items

The contents of the carton indication conforms to EIAJ C-3 and the following items are indicated.

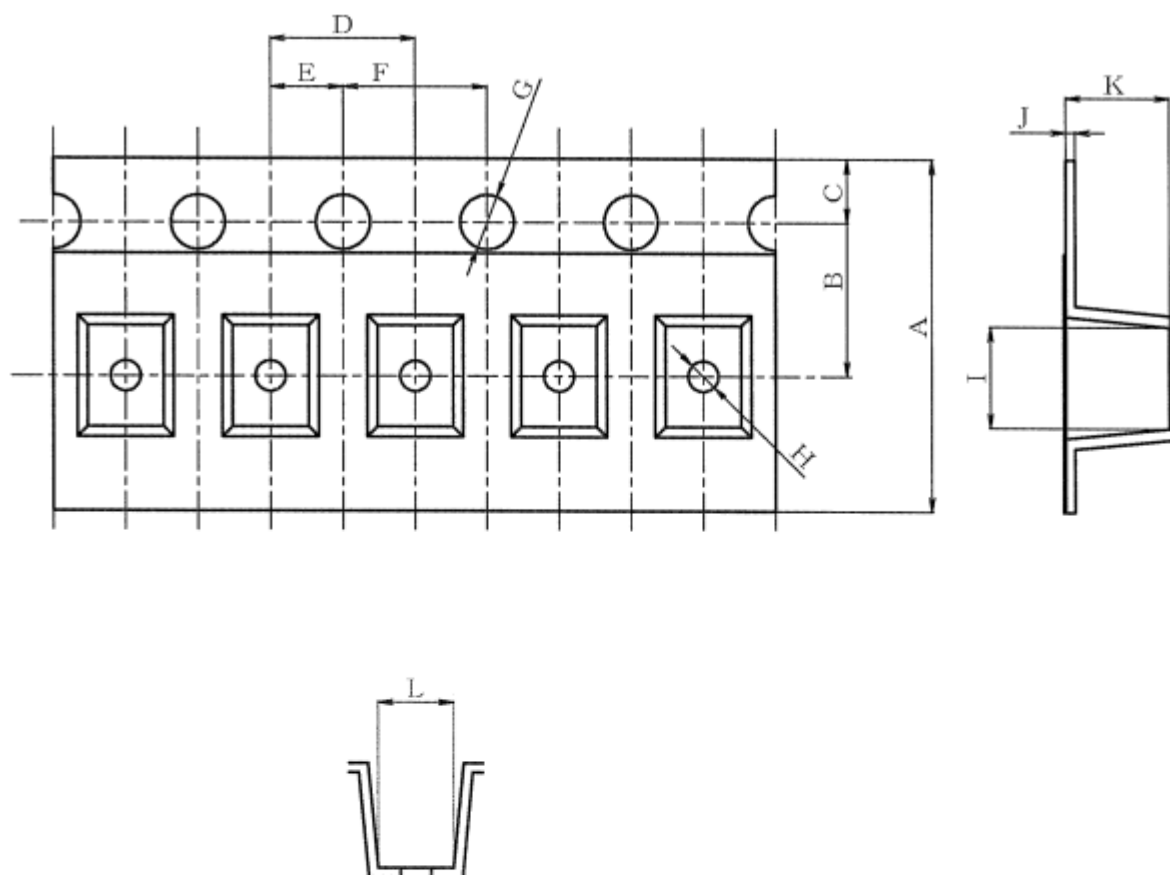
Model No., Internal production control name, Quantity, Packing date, Corporate name, Country of origin

7) Safety protection during shipping

There shall be no deformation of component or degradation of electrical characteristics due to shipping.

(Attachment-2-2)

●Tape structure and dimensions



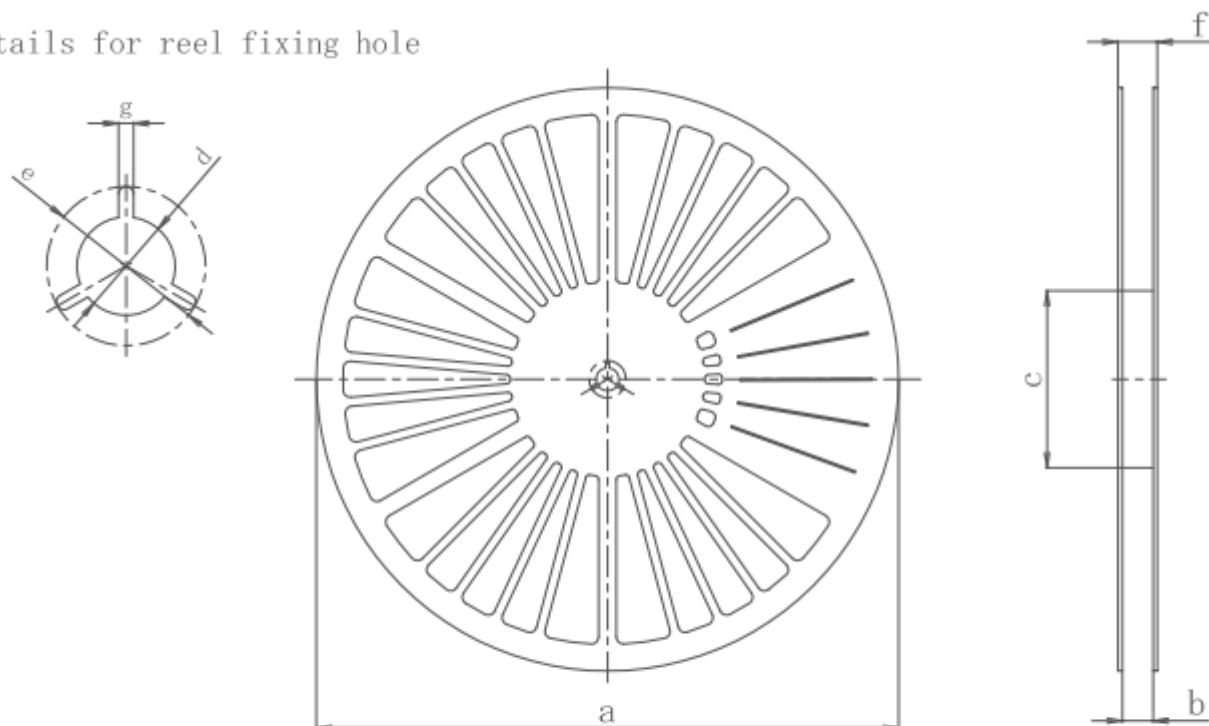
Symbol	Dimensions					
Unit	A	B	C	D	E	F
mm	8.0 ^{±0.3}	3.5 ^{±0.1}	1.75 ^{±0.1}	4.0 ^{±0.1}	2.0 ^{±0.1}	4.0 ^{±0.1}

Symbol	Dimensions					
Unit	G	H	I	J	K	L
mm	φ 1.5 ^{+0.1} ₋₀	φ 1.0 ^{±0.2}	2.75 ^{±0.1}	0.30 ^{±0.05}	2.1 ^{±0.1}	2.0 ^{±0.1}

(Attachment-2-3)

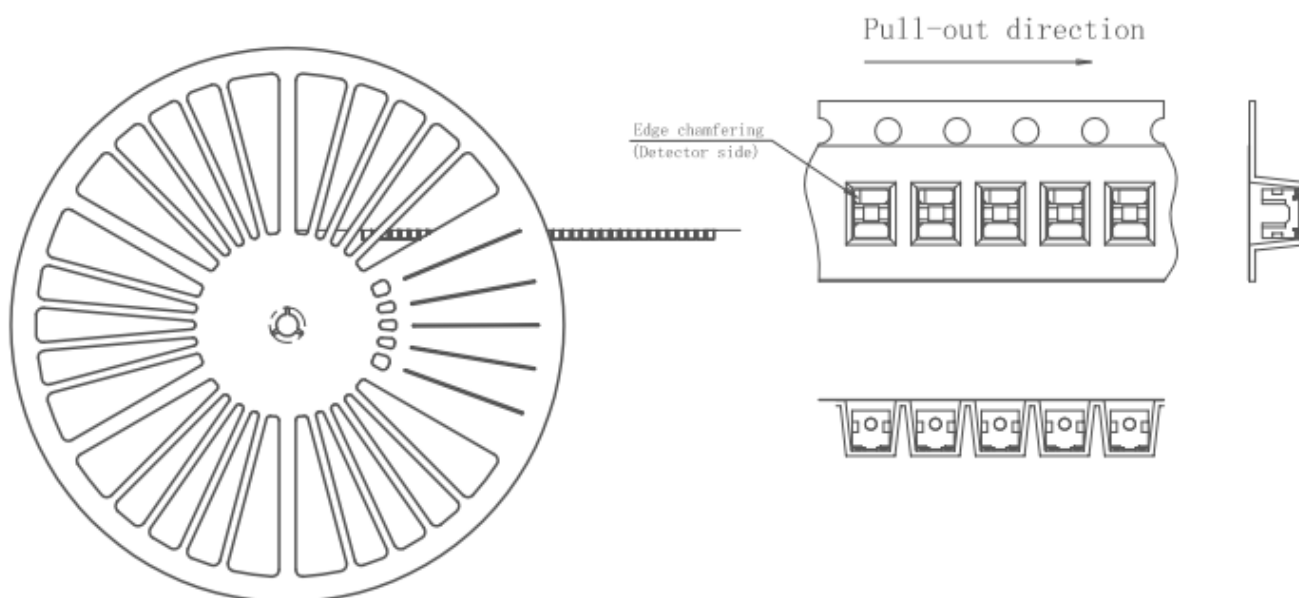
●Reel structure and dimensions

Details for reel fixing hole



Symbol Unit	Dimensions						
	a	b	c	d	e	f	g
mm	$\phi 180 \pm 2.0$	9.5 ± 1.0	$\phi 60 \pm 1.0$	$\phi 13 \pm 0.2$	21 ± 0.8	13.1 ± 1.0	2 ± 0.5

●Direction of product insertion



(Attachment-3-1)

Moisture-proof package specification

1) Application

This specification applies to the moisture-proof package for the GP1S396HCPSF.

2) Packaging specifications

(1) Packaging material

Name	Material
Aluminum laminated sack	Aluminum polyethylene
Label	Paper(-made)
Silica gel	-
Outer case	Paper(-made)
Cushioning material	Urethane

(2) Packaging method

- ① Seal a reel with 2,500pcs products into an aluminum laminated bag included the ruled silica gel quantity.
- ② Fill up the blank of label and paste on the bag.
- ③ Put the moisture-proof laminated bag in the ruled case (5bag/case).

Cushioning material is attached at both top and bottom of every bag.

Package shape	Product	Quantity	Moisture-proof sack Quantity
Tape-reel (φ 180mm)	Single	2,000pcs./reel	1reel/bag

Minimum order Quantity : 2,000pcs (1 reel/bag)

- ④ Fill out the model name, quantity and date after closing the outer case by craft tape.
(Quantity: 10,000pcs./case) *Except the case products by failing to seal are cut out

3) Storage and management after open

- (1) Storage condition : Storage shall be in accordance with the below conditions.

Storage temp. : 5 to 30°C

Storage humidity : 70%RH or less

- (2) Treatment after open

- ① After open, please mount at the conditions of humidity 60%RH or less and temperature 5 to 25°C within 2 days.
In case that two times reflow soldering are required, please complete your 2nd reflow soldering within 2 days after the 1st reflow soldering.

- ② In case of long time storage after open, please storage at the conditions of humidity 70%RH or less and temperature 5 to 30°C by using dry box or resealing with desiccant in moisture-proof bag by sealer and mount within 2 weeks.

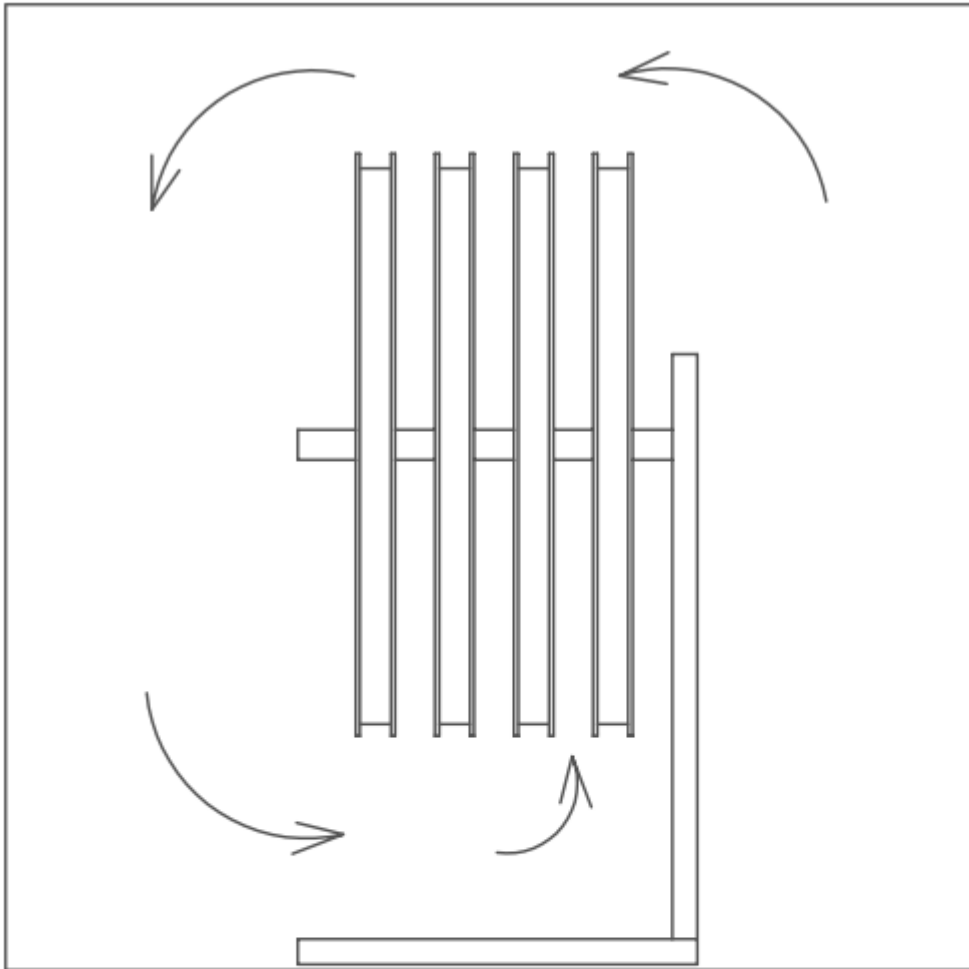
- (3) Baking before mounting

In case that it could not carry out the above treatment, it is able to mount with baking treatment. However baking treatment shall be limited only 1 time. Although it is possible to have baking treatment with taping package, please bake it by putting a reel with standing situation. Please do not lay it down since it may change the reel shape and occur a mounting problem. Since a label and a fixing tape for the carrier tape does not have enough heat resistance, there may be a case to leave some paste.

Recommended baking conditions : 100°C, 22 to 26 hours

(Attachment-3-2)

- Baking treatment before mounting
 - Placement of reels in an oven



- 1) Please hang reels by using a center hole for fixing the reel.
Please keep some space between reels for better air rotation in the oven.
Please do not lay a reel down in the oven to avoid any damages for the tape edge and the flange of reel.
- 2) Please make sure the carrier tape does not have any slack in a reel before baking to avoid peeling the cover tape off.
Since the tape using for fixing carrier tape is not heatproof, there is a case to remain glue.
So if necessary, please change the tape to a heatproof one.

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- Gas leakage sensor breakers
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